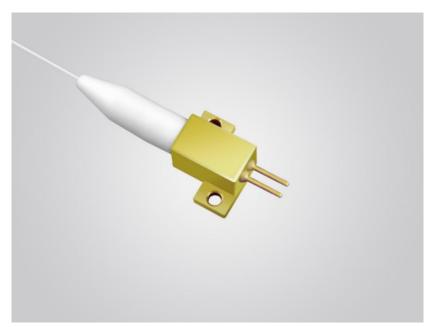


### RPK976S-3.000W-10522-NA



### Features:

- 976nm wavelength
- 3W output power
- 105µm fiber core diameter
- 0.22N.A.
- Narrow bandwidth △λ≤0.7nm
- 1040nm-1200nm feedback protection

### Applications:

Fiber laser pumping

High Power Diode Laser Modules are manufactured by adopting specialized fiber-coupling techniques, resulting in volume products with a high efficiency, stability and superior beam quality. The products are achieved by transforming the asymmetric radiation from the laser diode chip into an output fiber with small core diameter by using special micro optics. Inspecting and burn-in procedures in every aspect come to a result to guarantee each product with the reliability, stability and long lifetime.

Our research staffs are constantly improving and innovating the processing technology in the producing process, based on the professional knowledge and experience accumulated in long-terms. We are also continuously developing new products to meet customers' specific needs.

High quality products with reasonable price is our always goal.



### RPK976S-3.000W-10522-NA

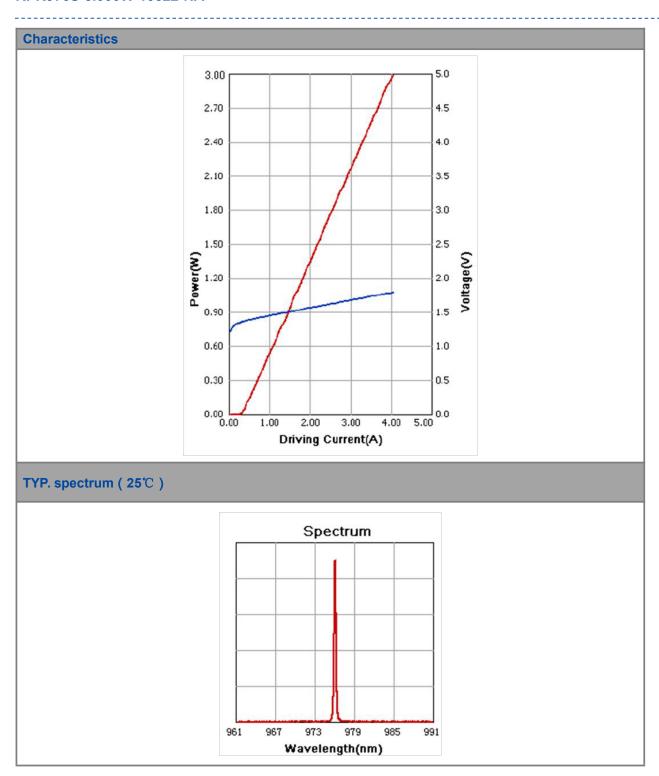
RPK976S-3.000W-10522-NA Specifications(25°C) **Symbol** Unit **Minimum Maximum Typical CW Output Power** Po 3 Threshold current 1  $I_{\text{th}}$ Α \_ Operating current  $I_{op}$ Α 13 Operating voltage  $V_{op}$ V 2 \_ Reverse Voltage  $V_{re}$ V 2.5 Slope Efficiency W/A 0.85 η Parameter(1) Electrical-to-Optical Efficiency PΕ % 40 Center wavelength 975.5 976.5 nm Spectral width(FWHM)  $\delta_{\lambda}$ 0.7 nm Back reflection wavelength Range 1040 1200 λ nm Back reflection isolation dΒ 30 Wavelength Shift with Temperature nm/℃ 0.02 Light within 0.15NA NA 95 Life Time MTTF hrs 100000 Buffer diameter  $D_{\text{buf}} \\$ 250 μm Cladding diameter 125  $\mathsf{D}_{\mathsf{clad}}$ μm μm 105 Core diameter D<sub>core</sub> **Fiber Date** Numeric aperture NA 0.22 Fiber length (2) lf 1 m Fiber Bend Radius 37.5 mm \_ **ESD**  $V_{\text{esd}}$ 500 -20 Storage temperature 70  $T_{stg}$ Tis  $^{\circ}\! \mathbb{C}$ 260 Lead Soldering Temp Others Lead Soldering Time 10 t sec \_ Operating case temperature 25 30  $T_{op}$ Relative Humidity RH% 15 75

<sup>(1)</sup> Data measured under operation output at 3W.

<sup>(2)</sup> Other fibers available upon request.

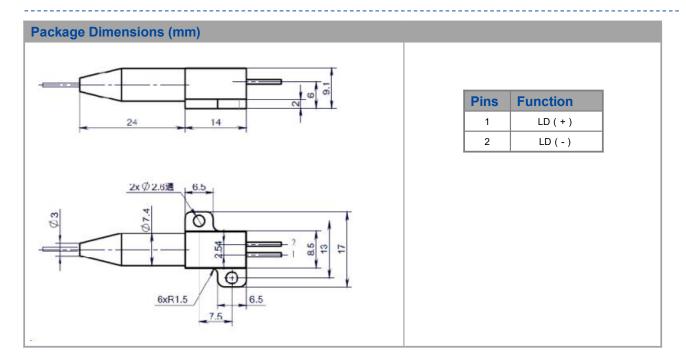


RPK976S-3.000W-10522-NA





#### RPK976S-3.000W-10522-NA



### **OPERATING NOTES**

- ◆ Avoid eye exposure to direct or scattered radiation.
- ♦ ESD precautions must be taken.
- ♦ Please connect pins to wires by solder instead of using socket when operation current is higher than 6A.
- ♦ Soldering point should be close to the root of the pins. Soldering temperature should be lower than 260℃ and time shorter than 10 second.
- ◆ Use constant current power supply. Avoid surge current.
- ♦ Laser diode must be used according to the specifications.
- ◆ Laser diode must work with good cooling.
- ◆ A minimum bend radius should be 300 times greater than the fiber cladding diameter, dynamic bend radius should be 400 times greater than the fiber cladding diameter.
- ♦ Storage: -20 °C ~ +70 °C, all pins short-circuit.

